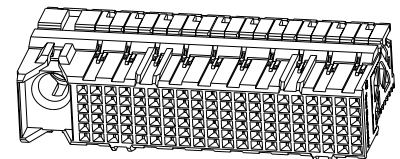
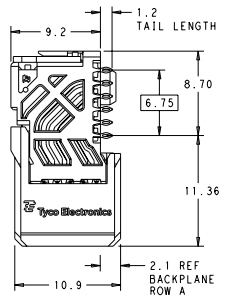
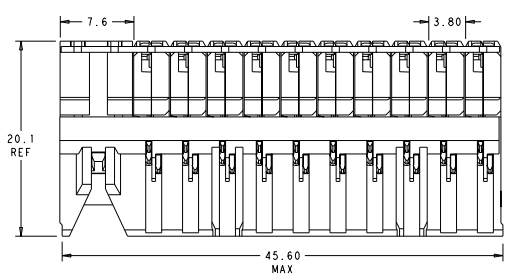


REV	DATE	DESCRIPTION	BY	CHK	APP
4		REVISED PER ECO-12-000416			

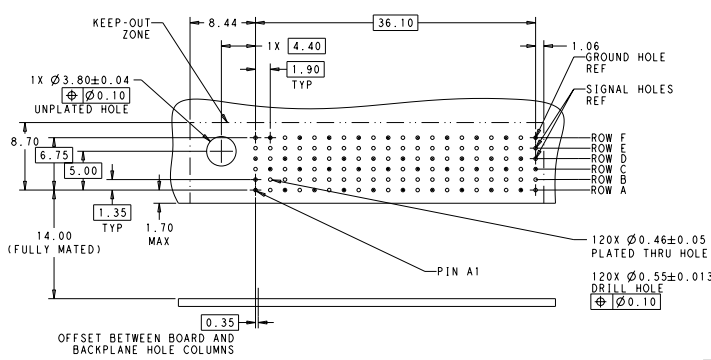
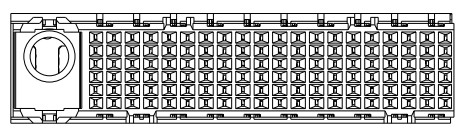
△ MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

△ FINISH:
30μ" SELECTIVE GOLD IN CONTACT AREA, SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.

△ FINISH:
30μ" SELECTIVE GOLD IN CONTACT AREA, SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1



OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.6

DESIGN APPROVED THIS PRINT IS
PRELIMINARY
TO FIRST PIECE APPROVAL
CONTACT PRODUCT ENGINEERING
BEFORE USING THIS PRINT

NONE	△	2143953-5
NONE	△	2143953-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. **IMP** MILLER 28SEP2015

DATE: 28SEP2015

DESIGNED BY: **SL** 28SEP2015

DATE: 28SEP2015

APPROVED BY: **SL**

DATE: 28SEP2015

APPLICATION SPEC: **IMPACT 32 PIN B, DAUGHTERCARD, 20 COLUMN, LEFT GUIDED, SIGNAL MODULE, 0.46 CIRCLE**

STATE: **A** | SCALE CODE: **00779** | PART NUMBER: **2143953** | REVISION: **1**

CUSTOMER DRAWING

TABLE 5:1 SHEET 1 OF 4